TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7W126FU**

#### **Dual BUS Buffer**

The TC7W126FU is a high speed  $C^2MOS$  Dual BUS Buffers fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the  $C^2MOS$  low power dissipation.

The require 3-state control input G to be set low to place the output into the high impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

# SSOP8-P-0.65

Weight: 0.02 g (typ.)

#### **Features**

- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 6 mA (min)
- Balanced propagation delays:  $t_pLH \simeq t_pHL$
- Wide operating voltage range: VCC (opr) = 2 to 6 V

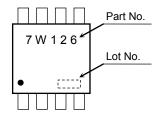
#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	$-0.5$ to $V_{CC} + 0.5$	V
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC} + 0.5$	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±37.5	mA
Power dissipation	P <sub>D</sub>	300	mW
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C
Lead temperature (10 s)	TL	260	°C

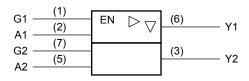
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

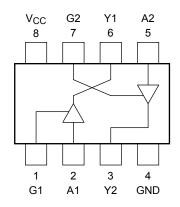
#### Marking



## **Logic Diagram**



# Pin Configuration (top view)



#### **Truth Table**

Inp	Output			
G	Α	Y		
L	Х	Z		
Н	L	L		
Н	Н	Н		

X: Don't care

Z: High impedance

## **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	<b>V</b>
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	>
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

#### **Electrical Characteristics**

#### **DC Electrical Characteristics**

Characteristics Symbol Test Condition		Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max				
					2.0	1.5	_	_	1.5	_	
	High level	V <sub>IH</sub>	_		4.5	3.15	_	_	3.15	_	
Input voltage					6.0	4.2	_	_	4.2	_	V
input voitage			_		2.0			0.5	_	0.5	V
	Low level	VIL			4.5			1.35	_	1.35	
					6.0	_	_	1.8	_	1.8	
	High level V <sub>C</sub>			I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	1.9	_	V
			$V_{IN} = V_{IH}$		4.5	4.4	4.5	_	4.4	_	
		V <sub>OH</sub>			6.0	5.9	6.0	_	5.9	_	
				$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
Output				$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
voltage				I <sub>OL</sub> = 20 μA	2.0	_	0	0.1	_	0.1	
					4.5	_	0	0.1	_	0.1	
Lo	Low level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		6.0	_	0	0.1	_	0.1	
				$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
				$I_{OL} = 7.8 \text{ mA}$	6.0		0.18	0.26	_	0.33	
3-state output off-state current $I_{OZ}$ $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		6.0	_	_	±0.5	_	±5.0	μА			
Input leakage of	current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	±0.1	_	±1.0	μА
Quiescent supply current $I_{CC}$ $V_{IN} = V_{CC}$ or GND		6.0	_	_	2.0	_	20.0	μА			



#### AC Electrical Characteristics (input $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
S. Id. dotto. I ot. 100	3,2	. 501 50114111511	CL	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	0
	t <sub>TLH</sub>	_	50	2.0		20	60	_	75	ns
Output transition time				4.5	_	6	12	_	15	
	THE			6.0		5	10	_	13	
			50	2.0		30	90	_	115	
				4.5		11	18	_	23	
Propagation delay time	t <sub>pLH</sub>			6.0		10	15	_	20	ns
Propagation delay time	t <sub>pHL</sub>	_		2.0		42	130	_	165	- lis
			150	4.5		14	26	_	33	
				6.0		12	22	_	28	
	<sup>t</sup> pZL <sup>t</sup> pZH		50	2.0		30	90	_	115	- ns
		$R_L = 1 \text{ k}\Omega$		4.5		11	18	_	23	
Output enable time				6.0		10	15	_	20	
Output enable time			150	2.0		42	130	_	165	
				4.5		14	26	_	33	
				6.0	_	12	22	_	28	
	$t_{pLZ}$ $t_{pHZ}$ $R_L = 1 \text{ k}\Omega$		50	2.0	_	24	100	_	125	ns
Output disable time		$R_L = 1 \text{ k}\Omega$		4.5		12	20	_	25	
				6.0	_	10	17	_	21	
Input capacitance	C <sub>IN</sub>	_		_		5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_		_		10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note)	_	_	_	41	_	_	_	pF

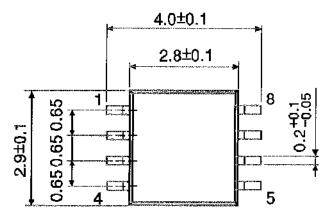
Note: C<sub>PD</sub> is defined as the value of internal equivalent capacitance which is calculated from the operating current consumption without load.

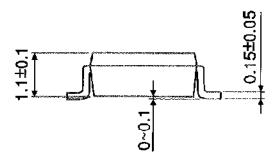
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per gate)}$ 

## **Package Dimensions**

SSOP8-P-0.65 Unit: mm





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Weight: 0.02 g (typ.)

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